

**ENV23T29** 



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification         | Test/Inspection Condition   | Reference/Spec              |
|-----------------------|---|-----------------------------|
| Operating Temperature | -20° to +80° C  | Individual Model Data Sheet |
| Storage Temperature   | -55° to 100° C<br>Ambient Environment   | Individual Model Data Sheet |
| Stabilization Bake    | (Non-operating)<br>125°C, 24 hours  |                             |
| DC Burn-in            | (DC on)<br>112 hours at 80°C  |                             |
| Thermal Shock         | -55°C to +100°C, 100 cycles,<br>15 mins dwell at extreme temperatures   | MIL-STD-202, Method 107     |
| Thermal Imaging       | With Output open, short and load conditions   |                             |
| Vibration             | Category 24, Exposure level figure 514C-17. General use, Random Vibration, 1 hr/axis 20-1000Hz - Amplitude PSD (0.040 G2/Hz). 1000 to 2000 Hz - Amplitude PSD (-6dB/octave) | MIL-STD-810F Method 514.5   |
| Mechanical Shock      | Terminal peak sawtooth,<br>40G's, 11 ms, 3 shocks +/-, Each Axis, 18 Shock Pulses Total   | MIL-STD-810F Method 516.5   |

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